### SN54F257, SN74F257 QUADRUPLE 2-LINE TO 1-LINE DATA SELECTORS/MULTIPLEXERS WITH 3-STATE OUTPUTS

SDFS065A - D2932, MARCH 1987 - REVISED OCTOBER 1993

- 3-State Outputs Interface Directly With System Bus
- Provides Bus Interface From Multiple Sources in High-Performance Systems
- Package Options Include Plastic Small-Outline Packages, Ceramic Chip Carriers, and Standard Plastic and Ceramic 300-mil DIPs

#### description

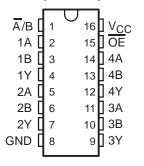
The 'F257 is designed to multiplex signals from 4-bit data sources to 4-output data lines in bus-organized systems. The 3-state outputs will not load the data lines when the output enable  $(\overline{OE})$  input is at a high logic level.

The SN54F257 is characterized for operation over the full military temperature range of  $-55^{\circ}$ C to 125°C. The SN74F257 is characterized for operation from 0°C to 70°C.

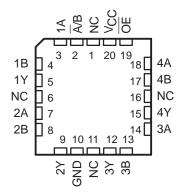
#### **FUNCTION TABLE**

	INPU	OUTPUT		
ŌĒ	Ā/B	Α	В	Υ
Н	Х	Χ	Х	Z
L	L	L	X	L
L	L	Н	X	Н
L	Н	Χ	L	L
L	Н	Χ	Н	Н

#### SN54F257 . . . J PACKAGE SN74F257 . . . D OR N PACKAGE (TOP VIEW)

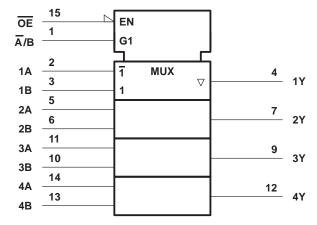


# SN54F257 . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

# logic symbol†

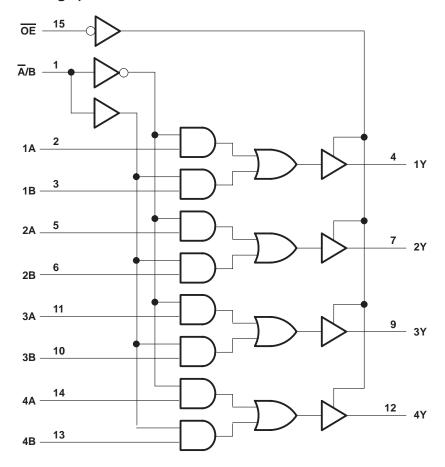


<sup>†</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for the D, J, and N packages.



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### logic diagram (positive logic)



Pin numbers shown are for the D, J, and N packages.

### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V <sub>CC</sub>	
Input current range	
Voltage range applied to any output in the disabled or power-off state	
Voltage range applied to any output in the high state	–0.5 V to V <sub>CC</sub>
Current into any output in the low state: SN54F257	40 mÅ
SN74F257	48 mA
Operating free-air temperature range: SN54F257	–55°C to 125°C
SN74F257	0°C to 70°C
Storage temperature range	–65°C to 150°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: The input voltage ratings may be exceeded provided the input current ratings are observed.



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### recommended operating conditions

		SN54F257			S	UNIT		
		MIN	NOM	MAX	MIN	NOM	MAX	UNII
VCC	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
VIH	High-level input voltage	2			2			V
V <sub>IL</sub>	Low-level input voltage			8.0			8.0	V
liK	Input clamp current			-18			-18	mA
IOH	High-level output current			-3			-3	mA
loL	Low-level output current			20			24	mA
TA	Operating free-air temperature	-55		125	0		70	°C

#### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

242445752		TEST CONDITIONS			7	S			
PARAMETER	TES	T CONDITIONS	MIN	TYP <sup>†</sup>	MAX	MIN	TYP <sup>†</sup>	MAX	UNIT
VIK	V <sub>CC</sub> = 4.5 V,	I <sub>I</sub> = –18 mA			-1.2			-1.2	V
	V 45V	$I_{OH} = -1 \text{ mA}$	2.5	3.4		2.5	3.4		
V <sub>OH</sub>	V <sub>CC</sub> = 4.5 V	$I_{OH} = -3 \text{ mA}$	2.4	3.3		2.4	3.3		V
	$V_{CC} = 4.75 V$ ,	$I_{OH} = -1 \text{ mA to } -3 \text{ mA}$				2.7			
.,	V 45V	I <sub>OL</sub> = 20 mA		0.3	0.5				.,
VOL	V <sub>CC</sub> = 4.5 V	I <sub>OL</sub> = 24 mA					0.35	0.5	V
lozh	$V_{CC} = 5.5 \text{ V},$	V <sub>O</sub> = 2.7 V			50			50	μΑ
lozL	V <sub>CC</sub> = 5.5 V,	V <sub>O</sub> = 0.5 V			-50			-50	μΑ
lı	V <sub>CC</sub> = 5.5 V,	V <sub>I</sub> = 7 V			0.1			0.1	mA
lін	V <sub>CC</sub> = 5.5 V,	V <sub>I</sub> = 2.7 V			20			20	μΑ
Ι <sub>Ι</sub> L	V <sub>CC</sub> = 5.5 V,	V <sub>I</sub> = 0.5 V			- 0.6			- 0.6	mA
los <sup>‡</sup>	V <sub>CC</sub> = 5.5 V,	VO = 0	-60		-150	-60		-150	mA
Іссн	J.,,	Condition A		9	15		9	15	
ICCL	V <sub>CC</sub> = 5.5 V, See Note 2	Condition B		14.5	22		14.5	22	mA
lccz	000110102	Condition C		15	23		15	23	

<sup>†</sup> All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C. ‡ Not more than one output should be shorted at a time, and the duration of the short circuit should not exceed one second.

NOTE 2: ICC is measured with the outputs open under the following conditions:

A. A/B and all B inputs at 4.5 V, other inputs grounded

B. All B inputs at 4.5 V, other inputs grounded

C. OE and all B data inputs at 4.5 V, other inputs grounded

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### switching characteristics (see Note 3)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	C <sub>I</sub> R′ Rí	CC = 5 V = 50 p 1 = 500 9 2 = 500 9 \( = 25^C\)	F, Ω, Ω,	C R R	CC = 4.5 L = 50 pl 1 = 500 s 2 = 500 s A = MIN	F, 2, Ω,		UNIT
			MIN	TYP	MAX	MIN	MAX	MIN	MAX	
t <sub>PLH</sub>	A == D	A or B Any Y	2.2	4.1	6	2.2	8	2.2	7	
<sup>t</sup> PHL	A or B		1.2	3.8	5.5	1	8	1.2	6.5	ns
<sup>t</sup> PLH	Ā/B	(D. A. )/	3.7	9.7	13	3.7	15.5	3.7	15	50
<sup>t</sup> PHL	A/B	Any Y	2.7	6.1	8.5	2.7	10.5	2.7	9.5	ns
<sup>t</sup> PZH	G	A V	2.2	5.5	7.5	2.2	9.5	2.2	8.5	
t <sub>PZL</sub>	G	G Any Y	2.2	5.1	7.5	2.2	10	2.2	8.5	ns
t <sub>PHZ</sub>	IG	Any Y	1.2	3.9	6	1.2	7	1.2	7	200
t <sub>PLZ</sub>	G	Ally f	1.2	4.1	6	1.2	9.5	1.2	7	ns

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions. NOTE 3: Load circuits and waveforms are shown in Section 1.



www.ti.com 11-Nov-2025

#### PACKAGING INFORMATION

Orderable part number	Status	Material type	Package   Pins	Package qty   Carrier	RoHS	Lead finish/	MSL rating/	Op temp (°C)	Part marking
	(1)	(2)			(3)	Ball material	Peak reflow		(6)
						(4)	(5)		
SN74F257D	Obsolete	Production	SOIC (D)   16	-	-	Call TI	Call TI	0 to 70	F257
SN74F257DR	Active	Production	SOIC (D)   16	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	F257
SN74F257DR.A	Active	Production	SOIC (D)   16	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	F257
SN74F257N	Active	Production	PDIP (N)   16	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74F257N
SN74F257N.A	Active	Production	PDIP (N)   16	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74F257N
SN74F257NSR	Active	Production	SOP (NS)   16	2000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	74F257
SN74F257NSR.A	Active	Production	SOP (NS)   16	2000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	74F257

<sup>(1)</sup> Status: For more details on status, see our product life cycle.

- (3) RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.
- (4) Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.
- (5) MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.
- (6) Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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# **PACKAGE OPTION ADDENDUM**

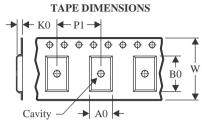
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# **PACKAGE MATERIALS INFORMATION**

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### TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE

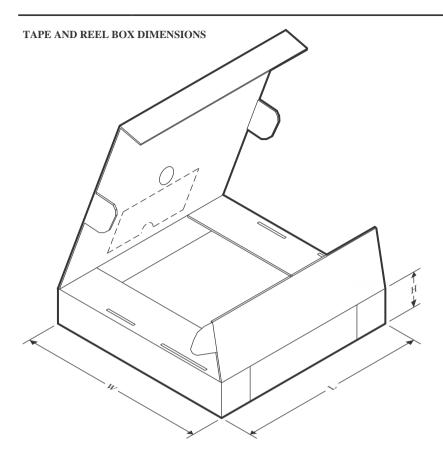


#### \*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74F257DR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1
SN74F257NSR	SOP	NS	16	2000	330.0	16.4	8.1	10.4	2.5	12.0	16.0	Q1

**PACKAGE MATERIALS INFORMATION** 

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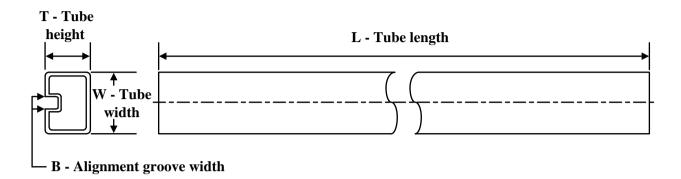
#### \*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74F257DR	SOIC	D	16	2500	340.5	336.1	32.0
SN74F257NSR	SOP	NS	16	2000	353.0	353.0	32.0

# **PACKAGE MATERIALS INFORMATION**

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### **TUBE**



\*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
SN74F257N	N	PDIP	16	25	506	13.97	11230	4.32
SN74F257N	N	PDIP	16	25	506	13.97	11230	4.32
SN74F257N.A	N	PDIP	16	25	506	13.97	11230	4.32
SN74F257N.A	N	PDIP	16	25	506	13.97	11230	4.32

# D (R-PDS0-G16)

### PLASTIC SMALL OUTLINE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AC.



# N (R-PDIP-T\*\*)

### PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



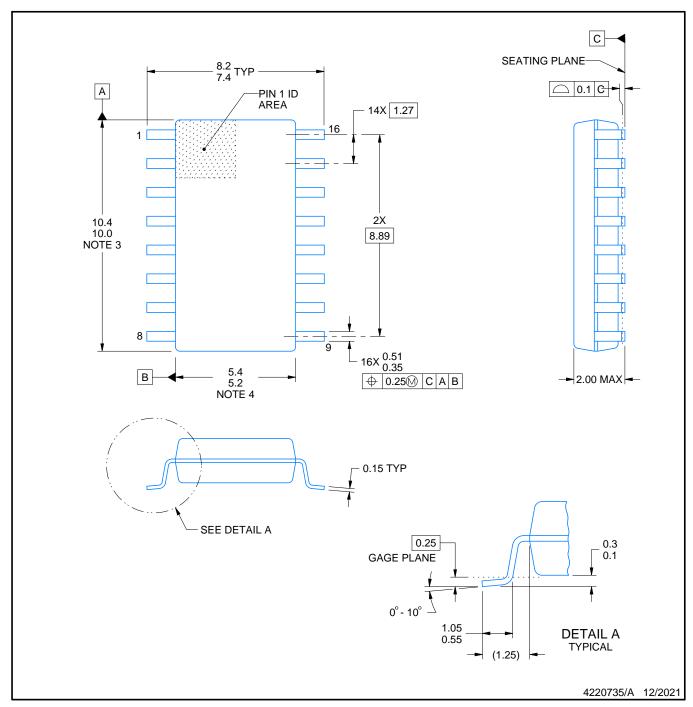
NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.





SOP



#### NOTES:

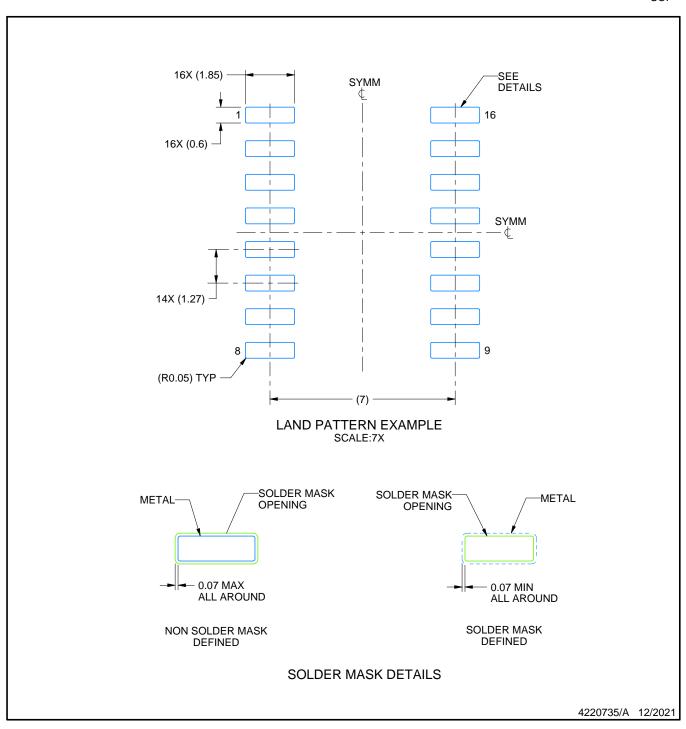
- 1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing
- per ASME Y14.5M.

  2. This drawing is subject to change without notice.

  3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm, per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm, per side.



SOF

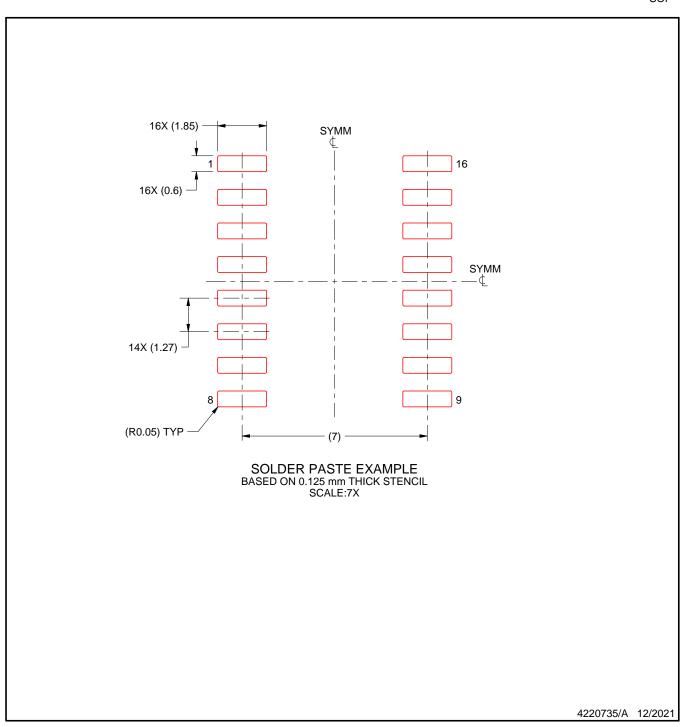


### NOTES: (continued)

- 5. Publication IPC-7351 may have alternate designs.
- 6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SOF



#### NOTES: (continued)

- 7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 8. Board assembly site may have different recommendations for stencil design.



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